



**THE DATASHEET OF  
SUD50NP04-77P-E3**



# Complementary N- and P-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY				
	V <sub>DS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)
N-Channel	40	0.037 at V <sub>GS</sub> = 10 V	8	26
		0.046 at V <sub>GS</sub> = 4.5 V	8	
P-Channel	- 40	0.040 at V <sub>GS</sub> = - 10 V	- 8	25.5
		0.050 at V <sub>GS</sub> = - 4.5 V	- 8	

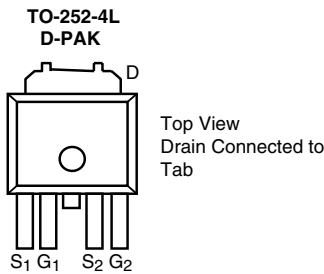
## FEATURES

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % UIS Tested

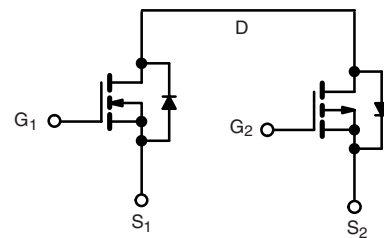


## APPLICATIONS

- Backlight Inverter for LCD Display
- Full Bridge DC/DC Converter



Ordering Information: SUD50NP04-77P-T4-E3 (Lead (Pb)-free)



N-Channel MOSFET      P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted					
Parameter	Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage	V <sub>DS</sub>	40	- 40	V	
Gate-Source Voltage	V <sub>GS</sub>	± 20			
Continuous Drain Current (T <sub>J</sub> = 150 °C)	I <sub>D</sub>	T <sub>C</sub> = 25 °C	8 <sup>a</sup>	- 8 <sup>a</sup>	A
		T <sub>C</sub> = 70 °C	8 <sup>a</sup>	- 8 <sup>a</sup>	
		T <sub>A</sub> = 25 °C	8 <sup>a, b, c</sup>	- 8 <sup>a, b, c</sup>	
		T <sub>A</sub> = 70 °C	7 <sup>b, c</sup>	- 7 <sup>b, c</sup>	
Pulsed Drain Current (10 μs Pulse Width)	I <sub>DM</sub>	30	- 30	A	
Source-Drain Current Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	8 <sup>a</sup>		- 8 <sup>a</sup>
		T <sub>A</sub> = 25 °C	4.3 <sup>b, c</sup>	- 4.6 <sup>b, c</sup>	
Pulsed Source-Drain Current	I <sub>SM</sub>	30	- 30	mJ	
Single Pulse Avalanche Current	I <sub>AS</sub>	7	15		
Single Pulse Avalanche Energy	E <sub>AS</sub>	2.45	11.25	W	
Maximum Power Dissipation	P <sub>D</sub>	T <sub>C</sub> = 25 °C	10.8		24
		T <sub>C</sub> = 70 °C	6.9		15.3
		T <sub>A</sub> = 25 °C	5.2 <sup>b, c</sup>		5.6 <sup>b, c</sup>
		T <sub>A</sub> = 70 °C	3.3 <sup>b, c</sup>	3.6 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	N-Channel		P-Channel		Unit
		Typ.	Max.	Typ.	Max.	
Maximum Junction-to-Ambient <sup>b, d</sup>	R <sub>thJA</sub>	20	24	18	22	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	9.4	11.5	4.3	5.2	

Notes:

- a. Package Limited.
- b. Surface Mounted on 1" x 1" FR4 Board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 60 °C/W (N-Channel) and 52 °C/W (P-Channel).

SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
<b>Static</b>							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	N-Ch	40			V
		$V_{GS} = 0\text{ V}, I_D = -250\text{ }\mu\text{A}$	P-Ch	-40			
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250\text{ }\mu\text{A}$	N-Ch		44		mV/ $^\circ\text{C}$
		$I_D = -250\text{ }\mu\text{A}$	P-Ch		-41		
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250\text{ }\mu\text{A}$	N-Ch		-5.5		
		$I_D = -250\text{ }\mu\text{A}$	P-Ch		4.3		
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	N-Ch	1.4		2.5	V
		$V_{DS} = V_{GS}, I_D = -250\text{ }\mu\text{A}$	P-Ch	-1.4		-2.7	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$	N-Ch			100	nA
			P-Ch			-100	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 40\text{ V}, V_{GS} = 0\text{ V}$	N-Ch			1	$\mu\text{A}$
		$V_{DS} = -40\text{ V}, V_{GS} = 0\text{ V}$	P-Ch			-1	
		$V_{DS} = 40\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$	N-Ch			10	
		$V_{DS} = -40\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$	P-Ch			-10	
On-State Drain Current <sup>b</sup>	$I_{D(on)}$	$V_{DS} = 5\text{ V}, V_{GS} = 10\text{ V}$	N-Ch	10			A
		$V_{DS} = -5\text{ V}, V_{GS} = -10\text{ V}$	P-Ch	-10			
Drain-Source On-State Resistance <sup>b</sup>	$r_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 5\text{ A}$	N-Ch		0.0305	0.037	$\Omega$
		$V_{GS} = -10\text{ V}, I_D = -5\text{ A}$	P-Ch		0.030	0.040	
		$V_{GS} = 4.5\text{ V}, I_D = 4\text{ A}$	N-Ch		0.037	0.046	
		$V_{GS} = -4.5\text{ V}, I_D = -4\text{ A}$	P-Ch		0.036	0.050	
Forward Transconductance <sup>b</sup>	$g_{fs}$	$V_{DS} = 15\text{ V}, I_D = 5\text{ A}$	N-Ch		22		S
		$V_{DS} = -15\text{ V}, I_D = -5\text{ A}$	P-Ch		20		
<b>Dynamic<sup>a</sup></b>							
Input Capacitance	$C_{iss}$	$V_{DS} = 20\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	N-Ch		640		pF
			P-Ch		1555		
Output Capacitance	$C_{oss}$		N-Ch		73		
			P-Ch		176		
Reverse Transfer Capacitance	$C_{rss}$	$V_{DS} = -20\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	N-Ch		41		
			P-Ch		142		
Total Gate Charge	$Q_g$	$V_{DS} = 20\text{ V}, V_{GS} = 10\text{ V}, I_D = 5\text{ A}$	N-Ch		11.7	20	nC
		$V_{DS} = -20\text{ V}, V_{GS} = -10\text{ V}, I_D = -5\text{ A}$	P-Ch		38.5	60	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 20\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 5\text{ A}$	N-Ch		5.3	9.0	
			P-Ch		17	27	
Gate-Drain Charge	$Q_{gd}$	$V_{DS} = -20\text{ V}, V_{GS} = -4.5\text{ V}, I_D = -5\text{ A}$	N-Ch		1.9		
			P-Ch		4.2		
Gate Resistance	$R_g$	$f = 1\text{ MHz}$	N-Ch		2.2		$\Omega$
			P-Ch		3.0		



SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
<b>Dynamic<sup>a</sup></b>							
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 20\text{ V}$ , $R_L = 4\ \Omega$ $I_D \cong 5\text{ A}$ , $V_{GEN} = 10\text{ V}$ , $R_g = 1\ \Omega$	N-Ch		9	18	ns
Rise Time	$t_r$		P-Ch		10	20	
Turn-Off Delay Time	$t_{d(off)}$	P-Channel $V_{DD} = -20\text{ V}$ , $R_L = 4\ \Omega$ $I_D \cong -5\text{ A}$ , $V_{GEN} = -10\text{ V}$ , $R_g = 1\ \Omega$	N-Ch		11	20	
			P-Ch		14	25	
Fall Time	$t_f$		N-Ch		14	25	
			P-Ch		36	60	
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 20\text{ V}$ , $R_L = 4\ \Omega$ $I_D \cong 5\text{ A}$ , $V_{GEN} = 4.5\text{ V}$ , $R_g = 1\ \Omega$	N-Ch		8	16	
			P-Ch		10	20	
Rise Time	$t_r$		N-Ch		18	30	
			P-Ch		47	80	
Turn-Off Delay Time	$t_{d(off)}$	P-Channel $V_{DD} = -20\text{ V}$ , $R_L = 4\ \Omega$ $I_D \cong -5\text{ A}$ , $V_{GEN} = -4.5\text{ V}$ , $R_g = 1\ \Omega$	N-Ch		14	25	
			P-Ch		60	110	
Fall Time	$t_f$		N-Ch		14	25	
			P-Ch		35	60	
			N-Ch		10	20	
			P-Ch		13	25	
<b>Drain-Source Body Diode Characteristics</b>							
Continuous Source-Drain Diode Current	$I_S$	$T_C = 25\text{ }^\circ\text{C}$	N-Ch			8	A
			P-Ch			- 8	
Pulse Diode Forward Current <sup>a</sup>	$I_{SM}$		N-Ch			30	A
			P-Ch			- 30	
Body Diode Voltage	$V_{SD}$	$I_S = 2\text{ A}$	N-Ch		0.805	1.2	V
		$I_S = -2\text{ A}$	P-Ch		- 0.76	- 1.2	
Body Diode Reverse Recovery Time	$t_{rr}$	N-Channel $I_F = 2\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ , $T_J = 25\text{ }^\circ\text{C}$	N-Ch		19	30	ns
			P-Ch		22	40	
Body Diode Reverse Recovery Charge	$Q_{rr}$	P-Channel $I_F = -2\text{ A}$ , $di/dt = -100\text{ A}/\mu\text{s}$ , $T_J = 25\text{ }^\circ\text{C}$	N-Ch		14	25	nC
			P-Ch		22	40	
Reverse Recovery Fall Time	$t_a$		N-Ch		13		ns
			P-Ch		15		
Reverse Recovery Rise Time	$t_b$		N-Ch		6		ns
			P-Ch		7		

Notes:

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .

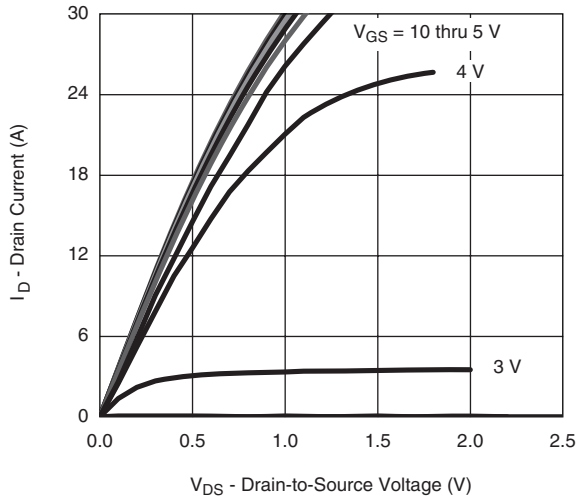
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

# SUD50NP04-77P

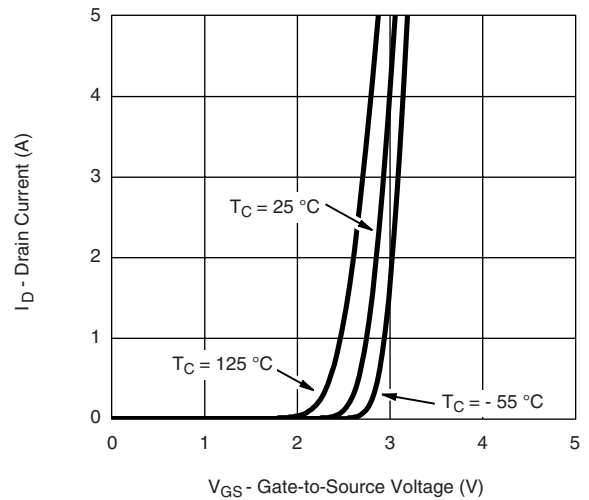


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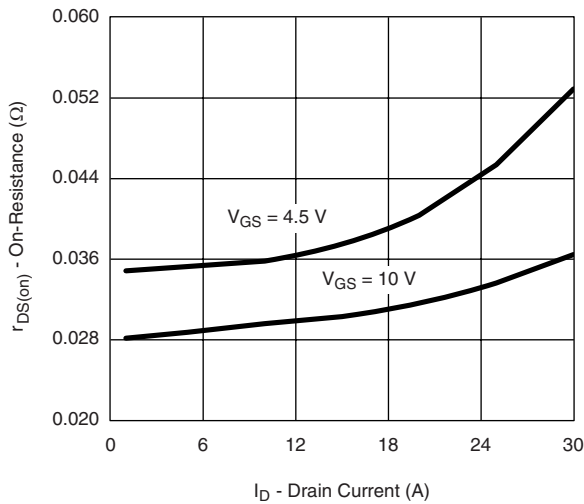
## N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



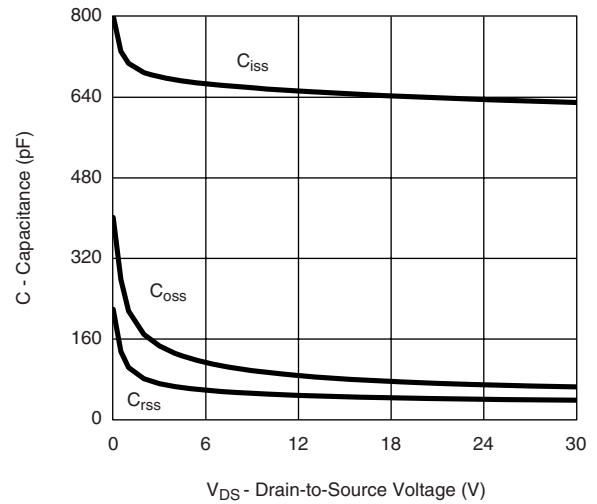
Output Characteristics



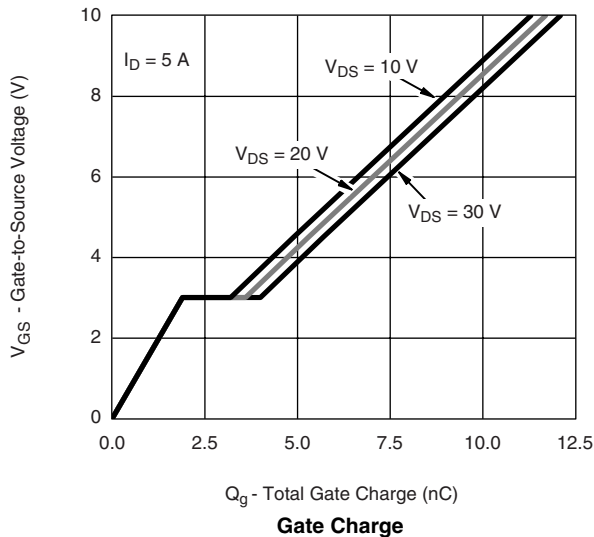
Transfer Characteristics



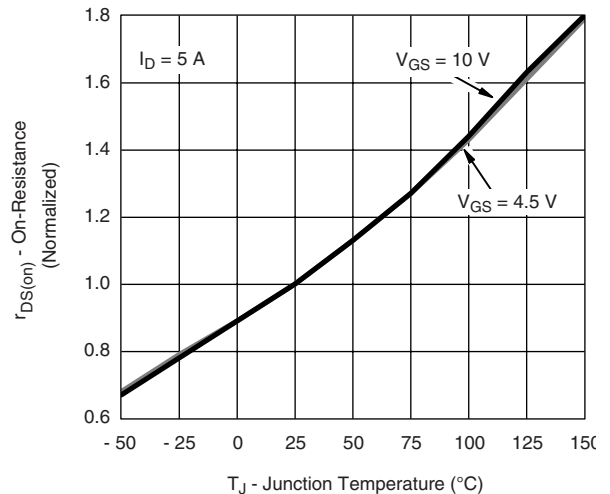
On-Resistance vs. Drain Current



Capacitance



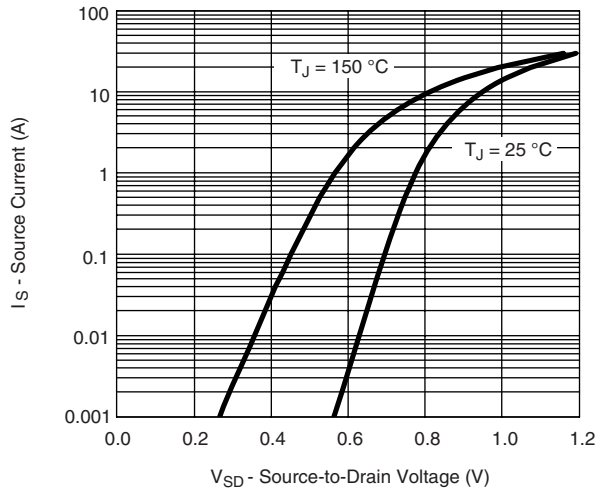
Gate Charge



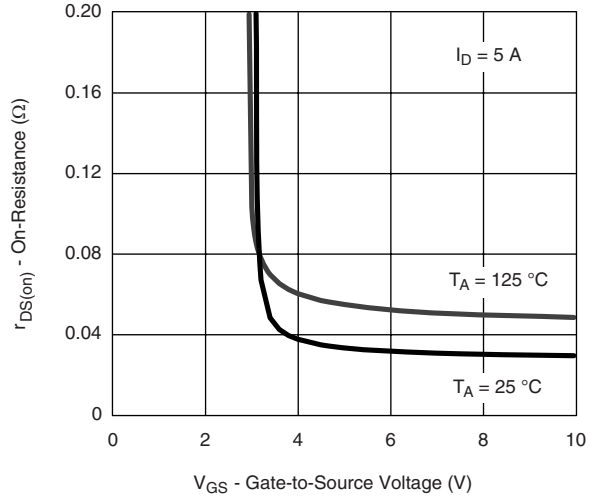
On-Resistance vs. Junction Temperature



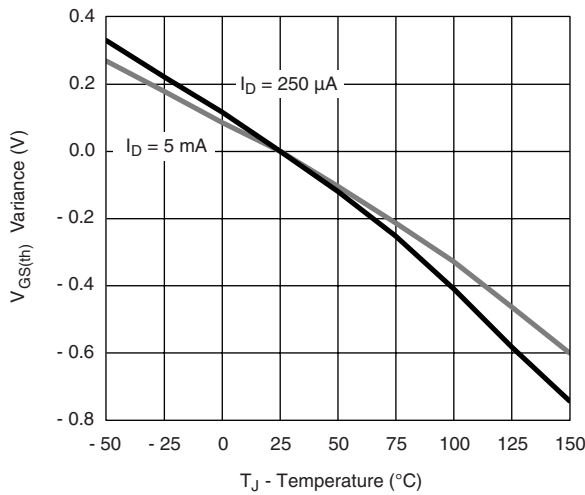
**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



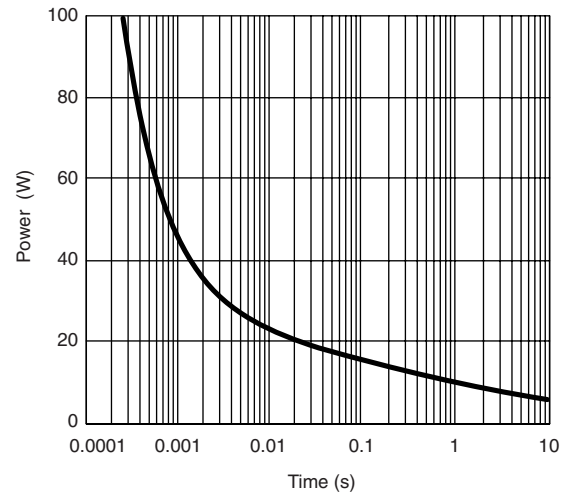
**Source-Drain Diode Forward Voltage**



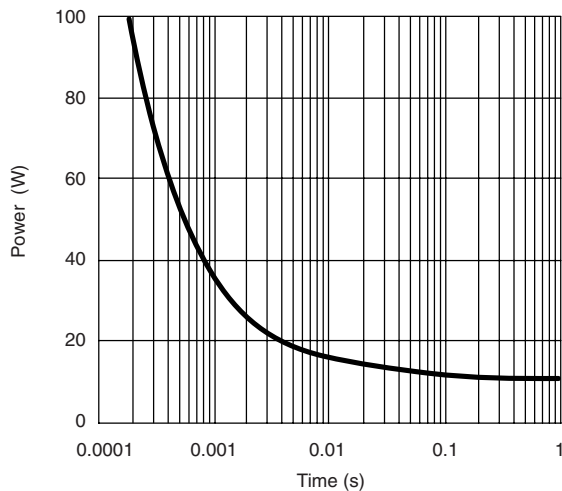
**On-Resistance vs. Gate-to-Source Voltage**



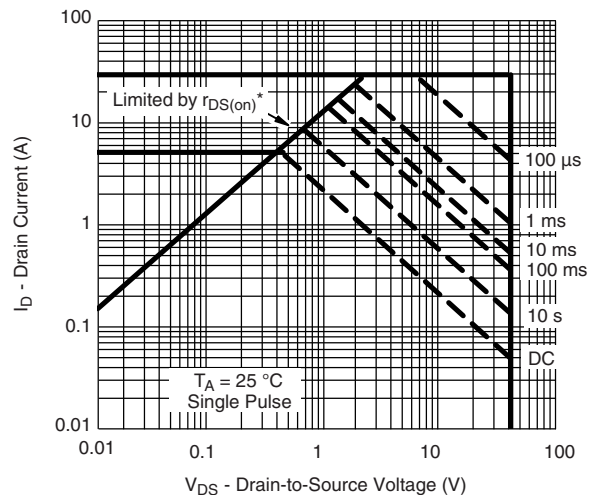
**Threshold Voltage**



**Single Pulse Power, Junction-to-Ambient**



**Single Pulse Power, Junction-to-Case**



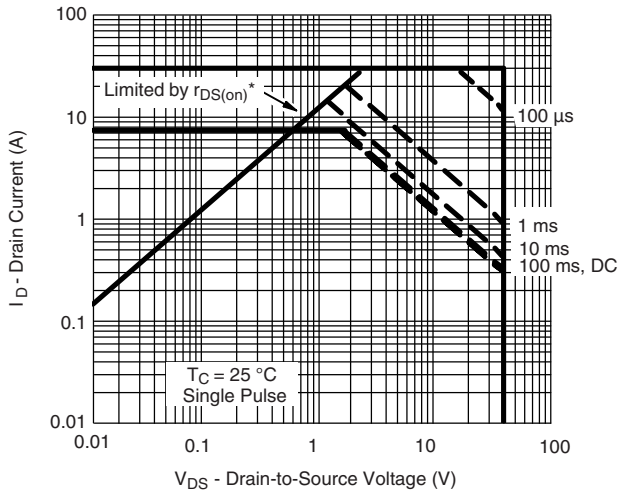
**Safe Operating Area, Junction-to-Ambient**

# SUD50NP04-77P

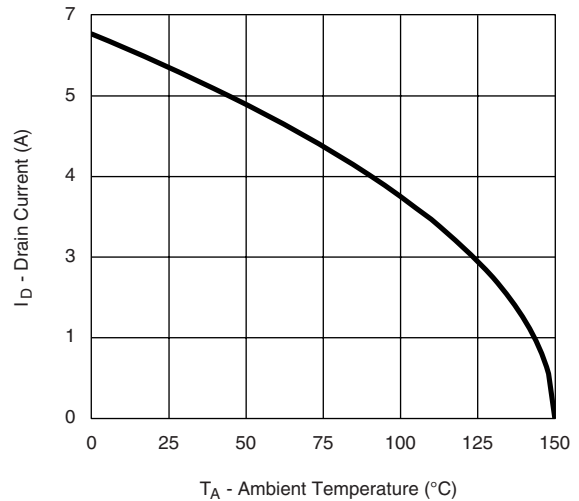


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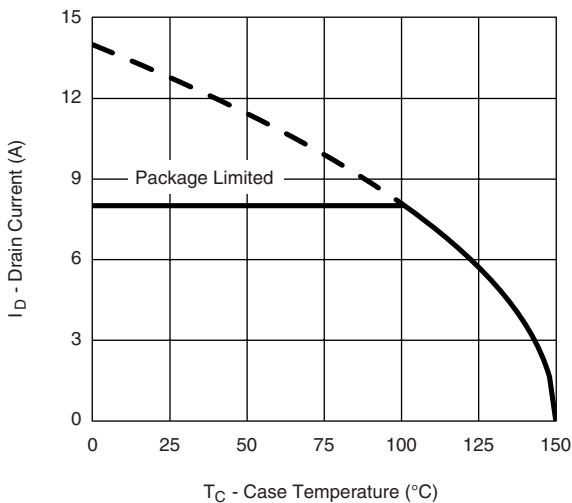
## N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



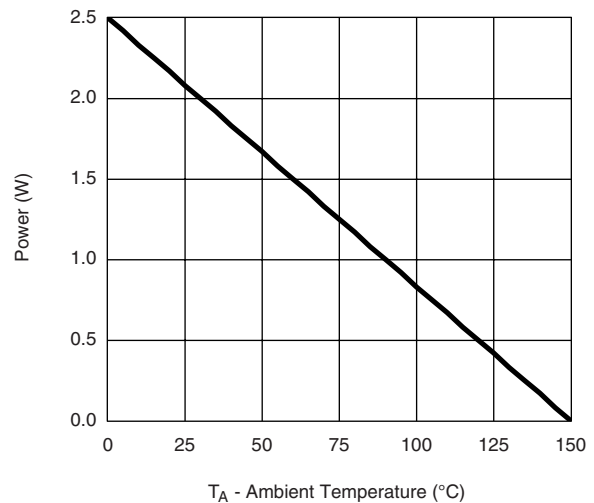
\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $r_{DS(on)}$  is specified  
**Safe Operating Area, Junction-to-Case**



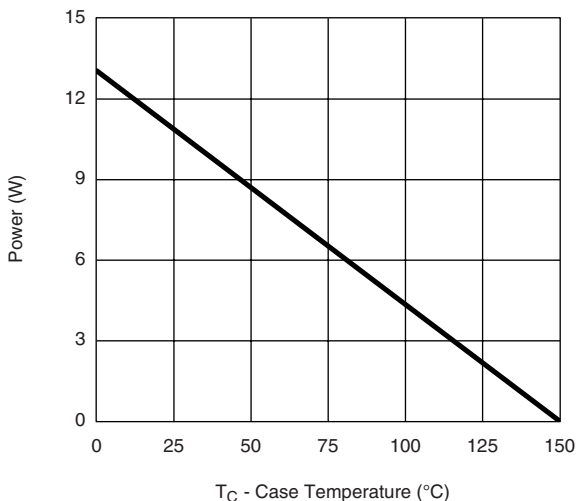
**Current Derating\*\*, Junction-to-Ambient**



**Current Derating\*\*, Junction-to-Case**



**Power Derating, Junction-to-Ambient**

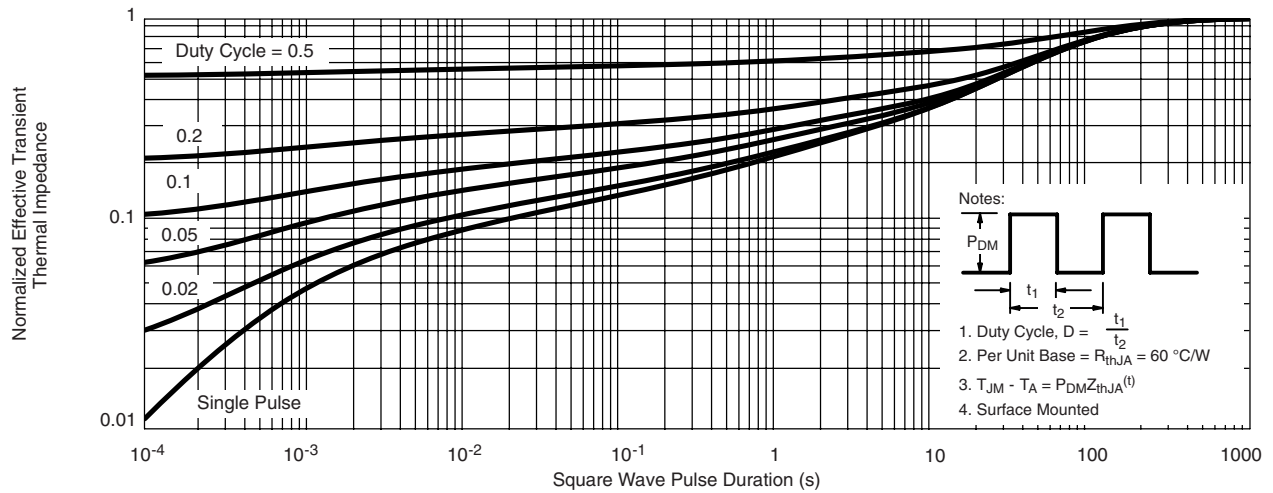


**Power Derating, Junction-to-Case**

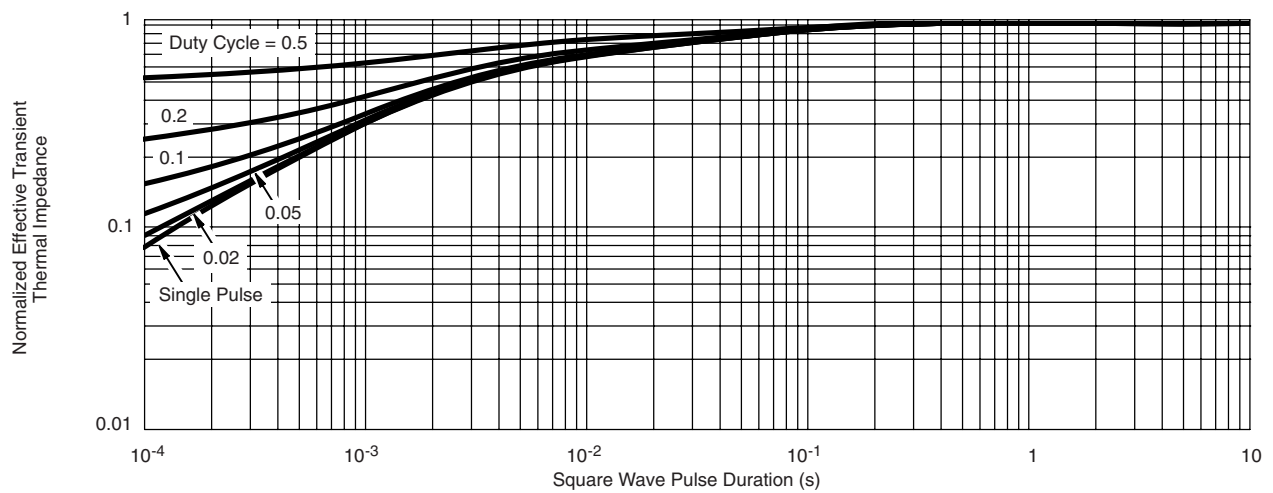
\*\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150\text{ }^\circ\text{C}$ , using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



**Normalized Thermal Transient Impedance, Junction-to-Ambient**



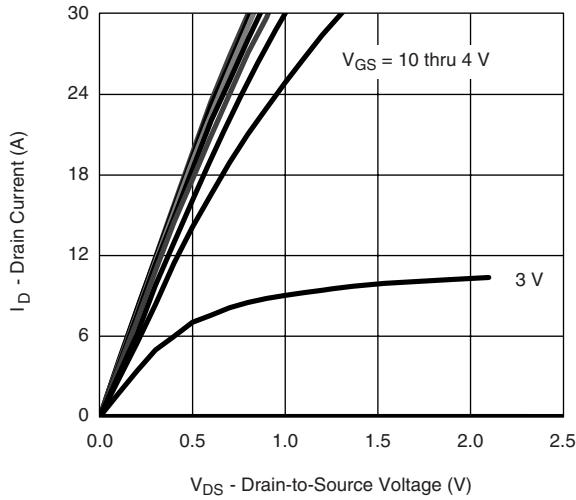
**Normalized Thermal Transient Impedance, Junction-to-Case**

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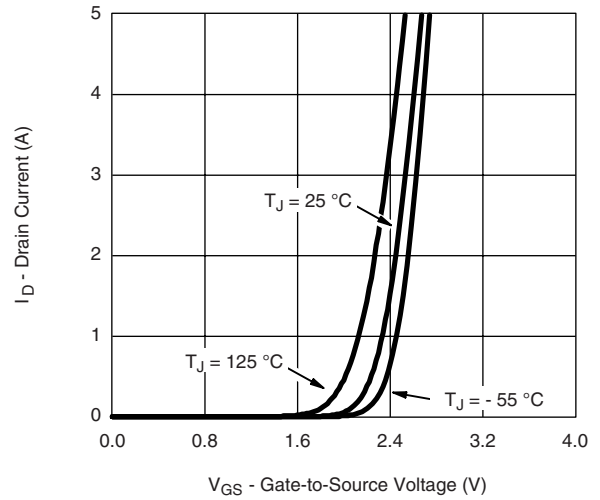


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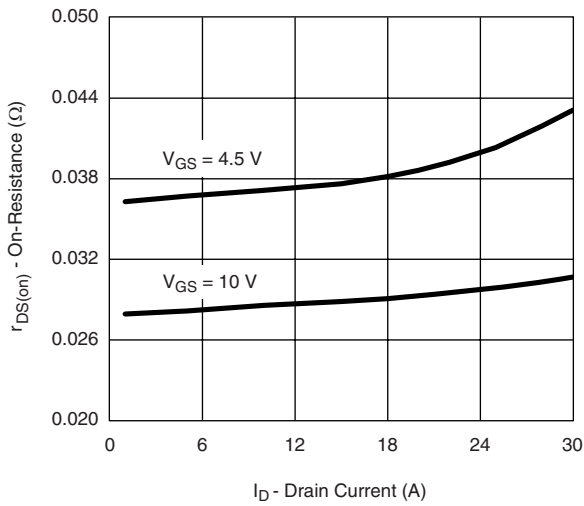
## P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



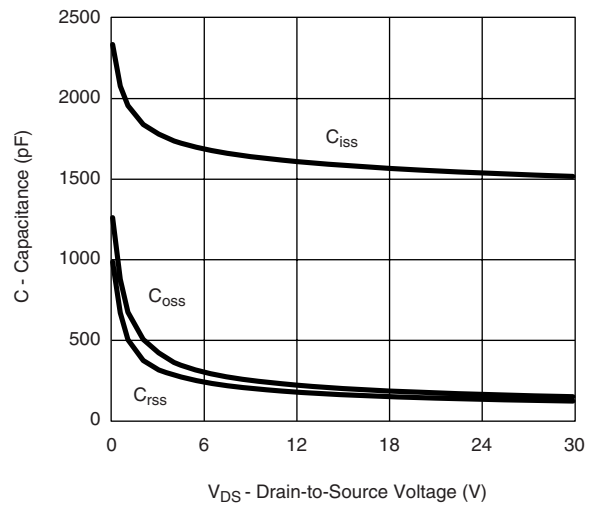
Output Characteristics



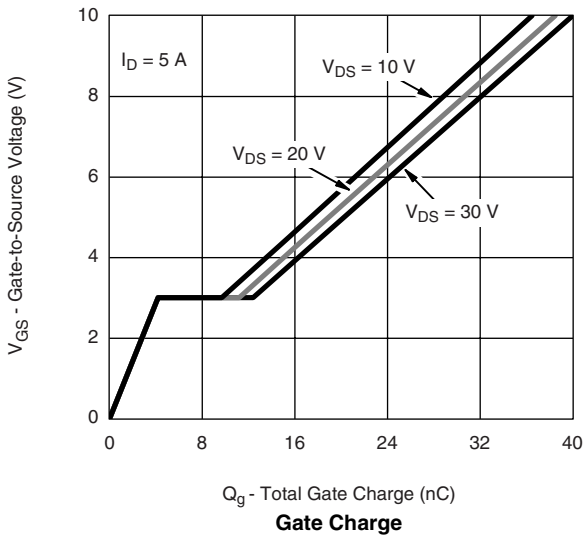
Transfer Characteristics



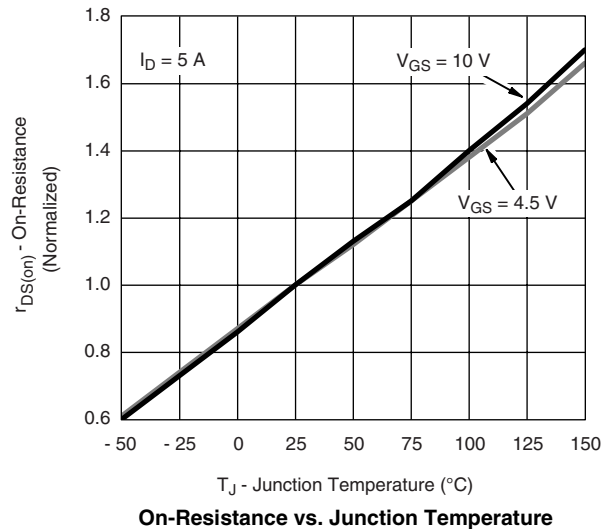
On-Resistance vs. Drain Current



Capacitance



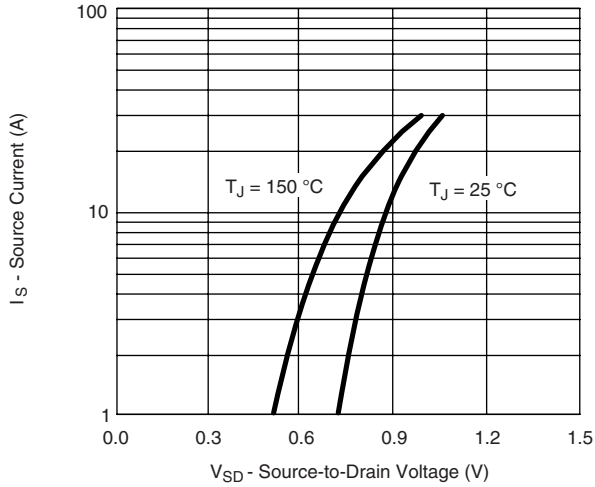
Gate Charge



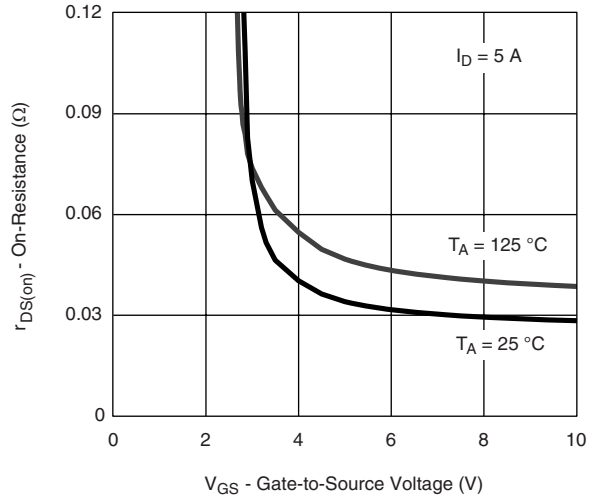
On-Resistance vs. Junction Temperature



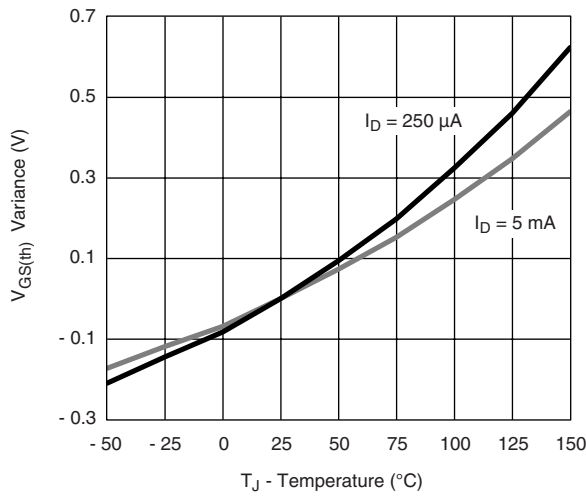
**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



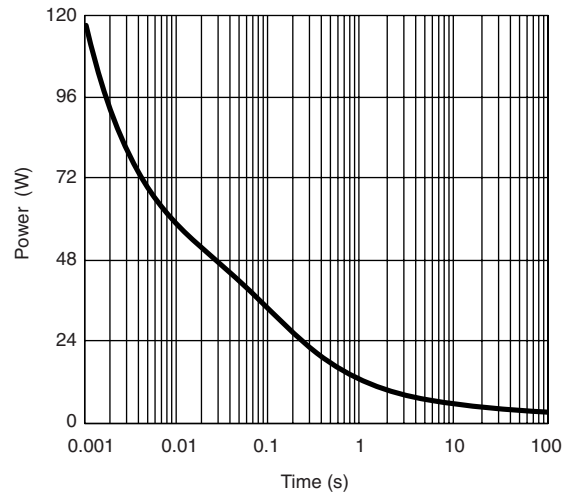
Source-Drain Diode Forward Voltage



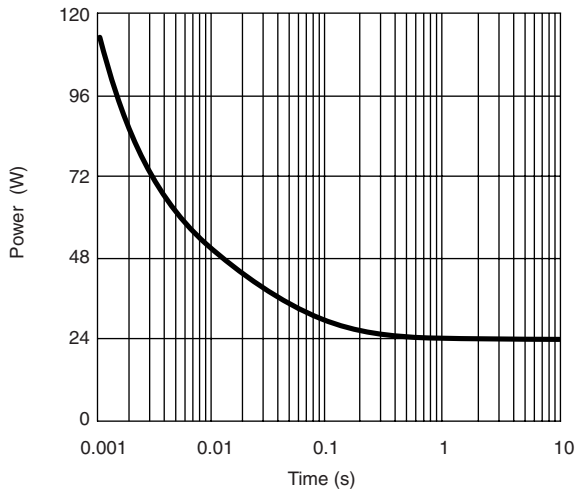
On-Resistance vs. Gate-to-Source Voltage



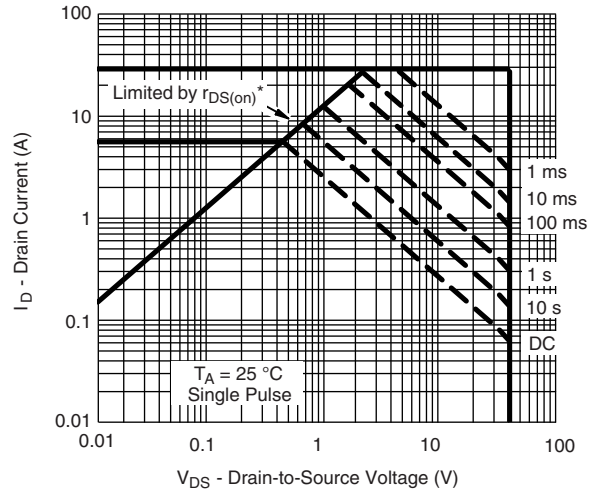
Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Single Pulse Power, Junction-to-Case



\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $r_{DS(on)}$  is specified

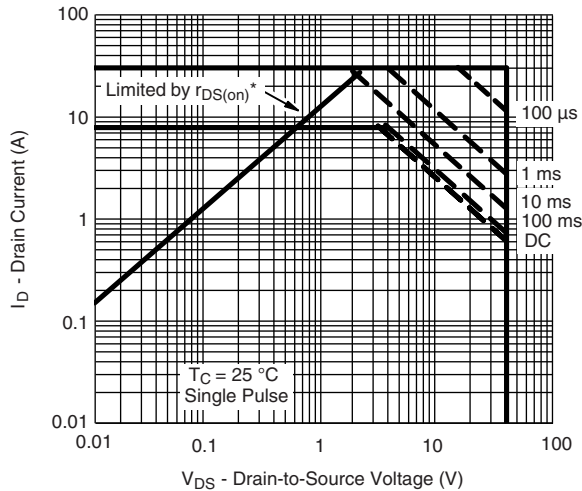
Safe Operating Area, Junction-to-Ambient

# SUD50NP04-77P



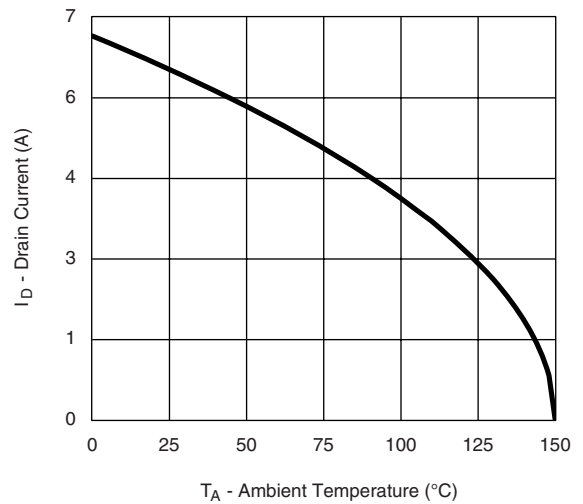
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## P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

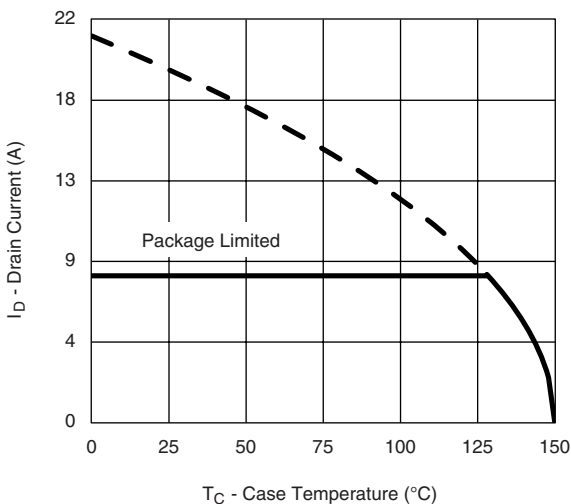


$V_{DS}$  - Drain-to-Source Voltage (V)  
\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $r_{DS(on)}$  is specified

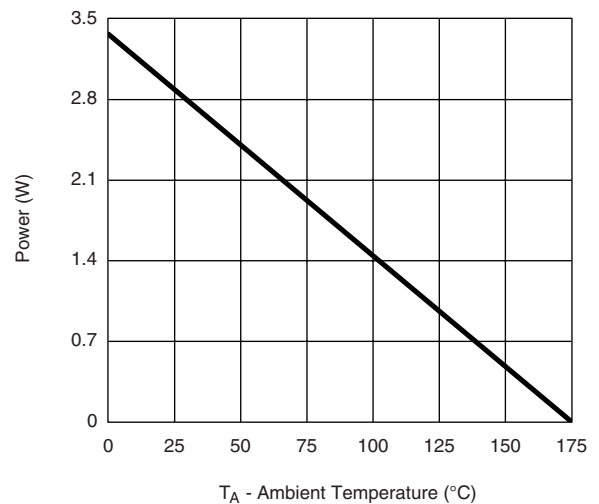
**Safe Operating Area, Junction-to-Case**



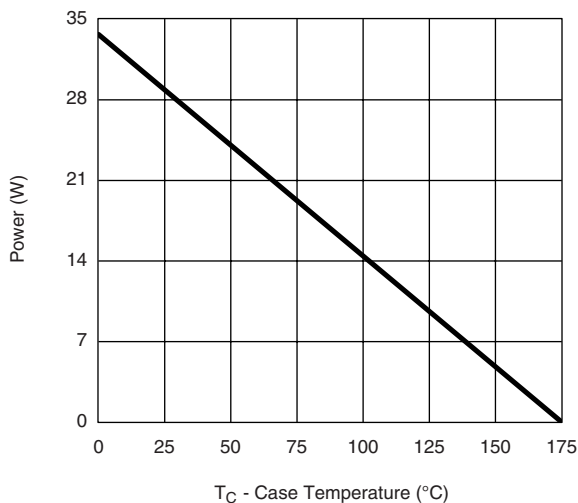
**Current Derating\*\*, Junction-to-Ambient**



**Current Derating\*\*, Junction-to-Case**



**Power Derating, Junction-to-Ambient**

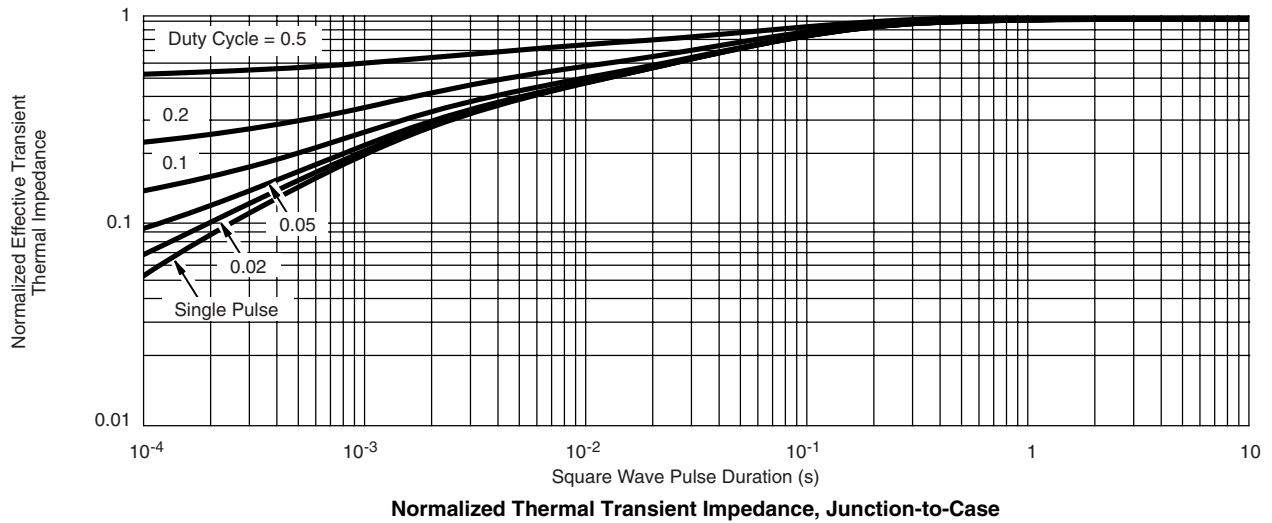
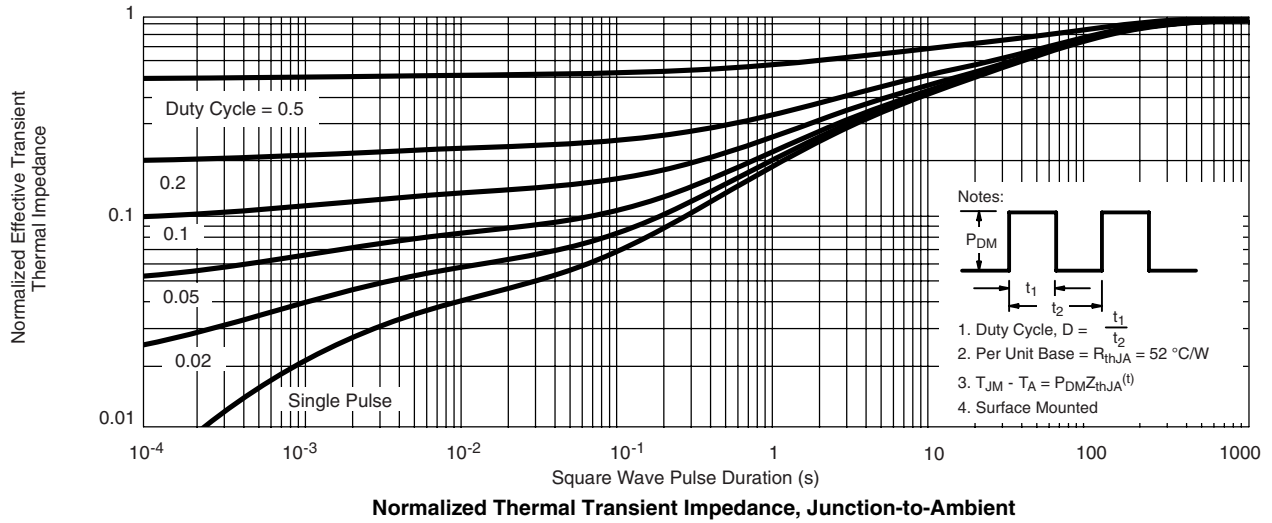


**Power Derating, Junction-to-Case**

\*\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150^\circ\text{C}$ , using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



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